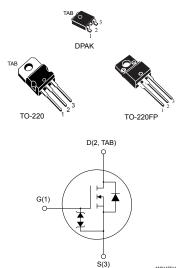


Datasheet

N-channel 600 V, 1.2 Ω typ., 5 A SuperMESH[™] Power MOSFET in DPAK, TO-220 and TO-220FP packages



Features

Order codes	V _{DS} @ T _{jmax.}	R _{DS(on)} max.	Package
STD5NK60ZT4			DPAK
STP5NK60Z	650 V	1.6 Ω	TO-220
STP5NK60ZFP			TO-220FP

• 100% avalanche tested

- Low input capacitance and gate charge
- Low gate input resistance

Applications

Switching applications

Description

These high-voltage devices are Zener-protected N-channel Power MOSFETs developed using the SuperMESH[™] technology by STMicroelectronics, an optimization of the well-established PowerMESH[™]. In addition to a significant reduction in on-resistance, these devices are designed to ensure a high level of dv/dt capability for the most demanding applications.

Product status link
STD4NK60ZT4
STP5NK60Z
STP5NK60ZFP



1 Electrical ratings

Ourseland	Devenueder	Valu	e	11	
Symbol	Parameter -	DPAK,TO-220	TO-220FP	– Unit	
V _{DS}	Drain-source voltage	600		V	
V _{GS}	Gate-source voltage	±30		V	
ID	Drain current (continuous) at T_C = 25 °C	5	5 (1)	A	
Ι _D	Drain current (continuous) at T_C = 100 °C	3.16	3.16 ⁽¹⁾	Α	
I _{DM} ⁽²⁾	Drain current (pulsed)	20	20 (1)	A	
P _{TOT}	Total dissipation at T_C = 25 °C	90	25	W	
ESD	Gate-source human body model (R = 1.5 k Ω , C = 100 pF)	3		kV	
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat-sink (t = 1 s, T_C = 25 °C)		2.5	kV	
dv/dt (3)	Peak diode recovery voltage slope	4.5	5	V/ns	
Тj	Operating junction temperature range			°C	
T _{stg}	Storage temperature range	-55 to	100	°C	

Table 1. Absolute maximum ratings

1. Limited by maximum junction temperature.

2. Pulse width limited by safe operating area.

3. $I_{SD} \leq 5 \text{ A}, \text{ di/dt} \leq 200 \text{ A/}\mu\text{s}, V_{DSpeak} \leq V_{(BR)DSS}, V_{DD} = 80\% V_{(BR)DSS}.$

Table 2. Thermal data

Symbol	Parameter		Value		Unit
Symbol	Faidinetei	DPAK	TO-220	TO-220FP	Unit
R _{thj-case}	Thermal resistance junction-case	1.39		5	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	62.5		°C/W	
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	50			°C/W

1. When mounted on 1 inch² FR-4, 2 Oz copper board.

Table 3. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not-repetitive (pulse width limited by T_{j} Max)	5	A
E _{AS}	Single pulse avalanche energy (starting T _j = 25 °C, $I_D = I_{AR}$, $V_{DD} = 50$ V)	220	mJ



2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1 mA, V _{GS} = 0 V	600			V
1	Zero gate voltage drain	V_{GS} = 0 V, V_{DS} = 600 V			1	μA
IDSS current	V_{GS} = 0 V, V_{DS} = 600 V, T_{C} = 125 °C $^{(1)}$			50	μA	
I _{GSS}	Gate body leakage current	V _{DS} = 0 V, V _{GS} = ±20 V			±10	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 50 \ \mu A$	3	3.75	4.5	V
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10 V, I _D = 2.5 A		1.2	1.6	Ω

Table 4. On/off states

1. Defined by design, not subject to production test.

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance			690		
C _{oss}	Output capacitance	V _{DS} = 25 V, f = 1 MHz, V _{GS} = 0 V	_	90		pF
C _{rss}	Reverse transfer capacitance			20		•
C _{oss eq.} ⁽¹⁾	Equivalent output capacitance	V_{DS} = 0 to 480 V, V_{GS} = 0 V	-	40		pF
Qg	Total gate charge	V _{DD} = 400 V, I _D = 5 A, V _{GS} = 0 to 10 V		26	34	
Q _{gs}	Gate-source charge	(see Figure 16. Test circuit for gate charge	-	6		nC
Q _{gd}	Gate-drain charge	behavior)		14		

1. $C_{oss eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS} .

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 300 V, I _D = 2.5 A,		16		
t _r	Rise time	R_G = 4.7 Ω , V_{GS} = 10 V		25		
t _{d(off)}	Turn-off delay time	(see Figure 15. Test circuit for resistive load switching times and Figure 20. Switching		36		
t _r	Fall time	time waveform)		25		
t _{r(Voff)}	Off-voltage rise time	V _{DD} = 480 V, I _D = 5 A,	-	12	_	ns
t _f	Fall time	R_{G} = 4.7 Ω , V_{GS} = 10 V		10		
t _c	Cross-over time	(see Figure 17. Test circuit for inductive load switching and diode recovery times and Figure 20. Switching time waveform)		24		

Table 6. Switching times

Table 7. Source drain diode

Symbol	Parameter	Parameter Test conditions		Тур.	Max.	Unit
I _{SD}	Source-drain current	e-drain current			5	
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		20	A
V _{SD} ⁽²⁾	Forward on voltage	I_{SD} = 5 A, V_{GS} = 0 V	-		1.6	V
t _{rr}	Reverse recovery time	I _{SD} = 5 A, di/dt = 100 A/µs		485		ns
Q _{rr}	Reverse recovery charge	V _{DD} = 30 V (see Figure 17. Test circuit for inductive load switching and diode recovery	-	2.7		μC
I _{RRM}	Reverse recovery current	times)		11		А

1. Pulse width limited by safe operating area.

2. Pulsed: pulse duration = 300 μs, duty cycle 1.5%.

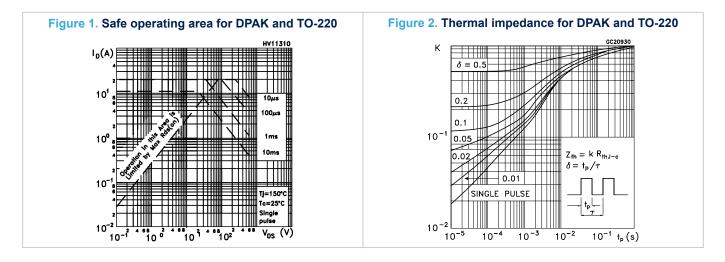
Table 8. Gate-Source Zener Diode

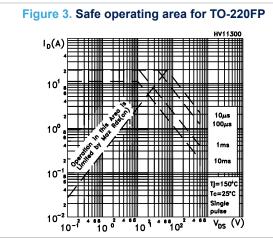
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)GSO}	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{ mA}, I_D = 0 \text{ A}$	30	-	-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.



2.1 Electrical characteristics curves





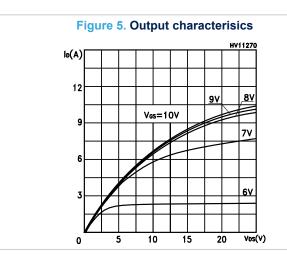
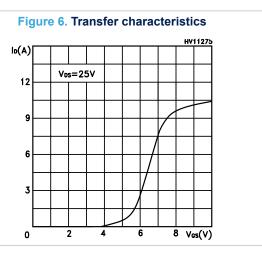


Figure 4. Thermal impedance for TO-220FP Κ δ=0. δ=0 δ=0 10 -`δ =0.05 δ =0.02 δ =0.01 Single pulse Z_{th}=K*R_{thj} 10 -2 $\delta = t_p / T$ 1 ſ 10 -3 $\overline{t}_{p}(s)$ 10 -4 10 - 3 10 -2 10 -1 10 0





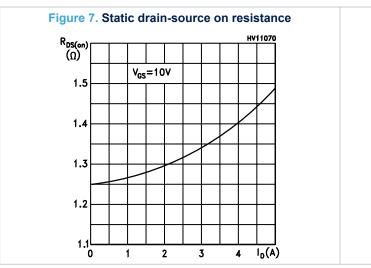


Figure 9. Capacitance variations

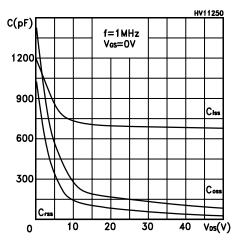


Figure 11. Normalized on resistance vs temperature HV11295 Ros(on) (norm) 2.5 2.0 1.5 Vas=10∨ 1.0 I₀=2.5A 0.5 0 150 TJ °C> -100 -50 0 50 100

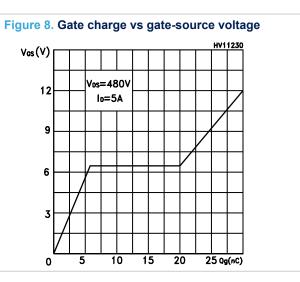


Figure 10. Normalized gate threshold voltage vs temperature

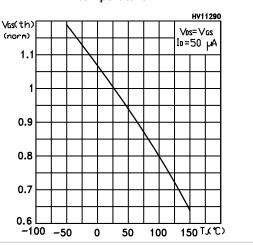
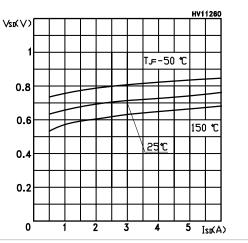
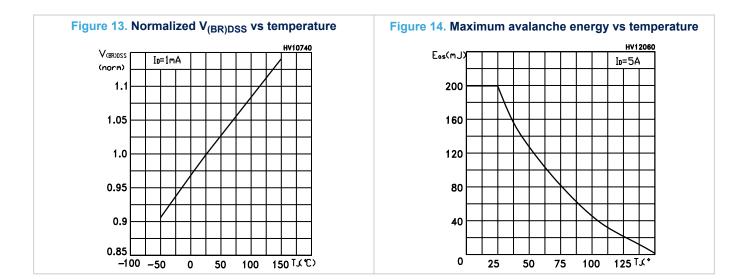


Figure 12. Source-drain diode forward characteristic

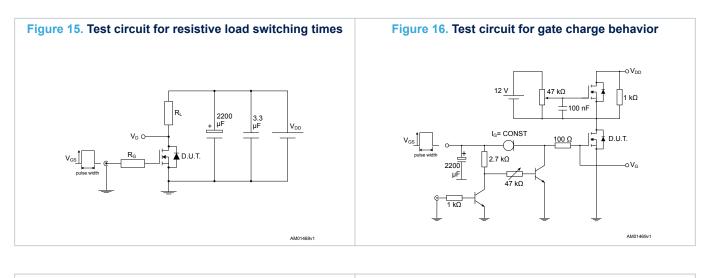


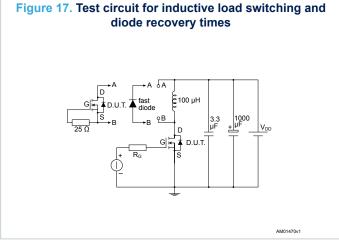


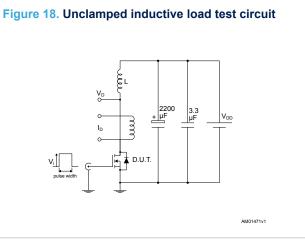


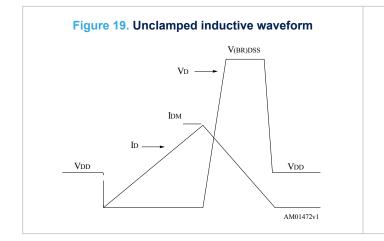


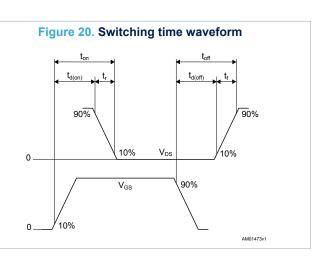
3 Test circuits













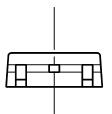
4 Package information

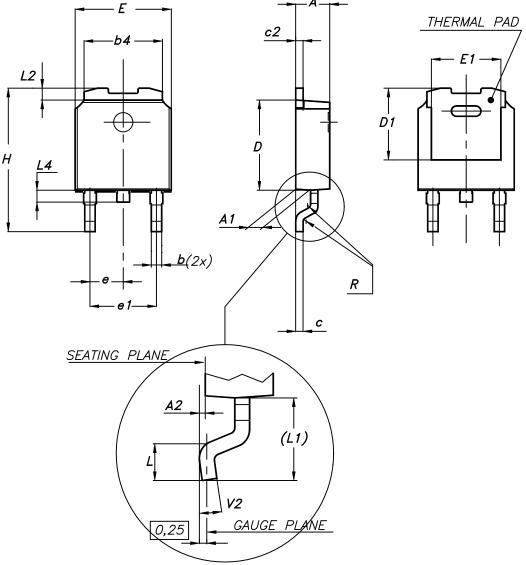
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.



4.1 DPAK (TO-252) type A2 package information

Figure 21. DPAK (TO-252) type A2 package outline





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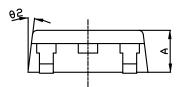
Dim.		mm	
Dini.	Min.	Тур.	Max.
A	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1	4.95	5.10	5.25
E	6.40		6.60
E1	5.10	5.20	5.30
e	2.159	2.286	2.413
e1	4.445	4.572	4.699
Н	9.35		10.10
L	1.00		1.50
L1	2.60	2.80	3.00
L2	0.65	0.80	0.95
L4	0.60		1.00
R		0.20	
V2	0°		8°

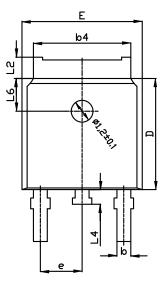
Table 9. DPAK (TO-252) type A2 mechanical data

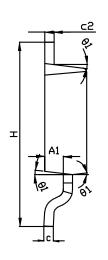


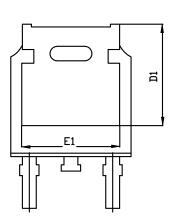
4.2 DPAK (TO-252) type C2 package information

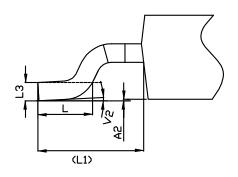
Figure 22. DPAK (TO-252) type C2 package outline











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Dim.		mm	
	Min.	Тур.	Max.
А	2.20	2.30	2.38
A1	0.90	1.01	1.10
A2	0.00		0.10
b	0.72		0.85
b4	5.13	5.33	5.46
С	0.47		0.60
c2	0.47		0.60
D	6.00	6.10	6.20
D1	5.10		5.60
E	6.50	6.60	6.70
E1	5.20		5.50
e	2.186	2.286	2.386
Н	9.80	10.10	10.40
L	1.40	1.50	1.70
L1	2.90 REF		
L2	0.90		1.25
L3	0.51 BSC		
L4	0.60	0.80	1.00
L6	1.80 BSC		
θ1	5°	7°	9°
θ2	5°	7°	9°
V2	0°		8°

Table 10. DPAK (TO-252) type C2 mechanical data

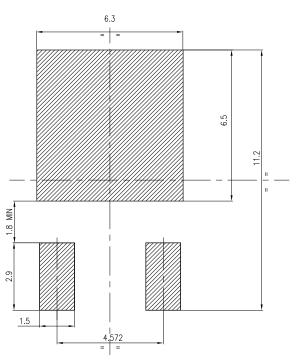


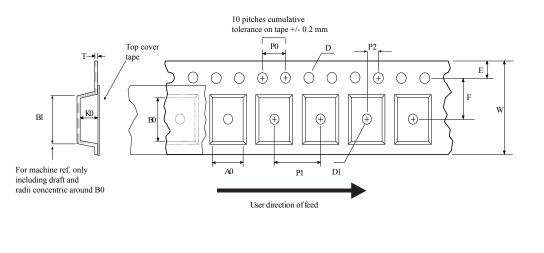
Figure 23. DPAK (TO-252) recommended footprint (dimensions are in mm)

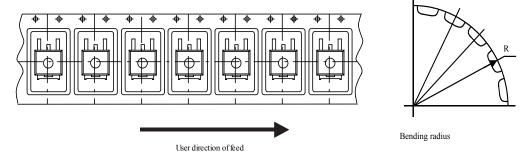
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4.3 DPAK (TO-252) packing information



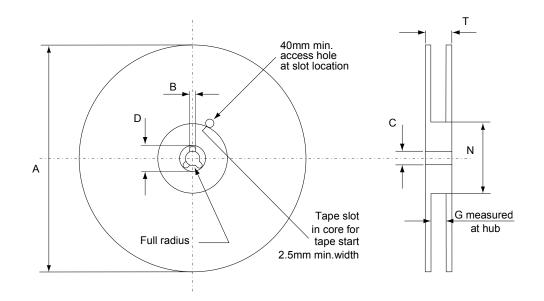




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AM06038v1

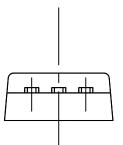
Table 11. DPAK (TO-252) tape and reel mechanical data

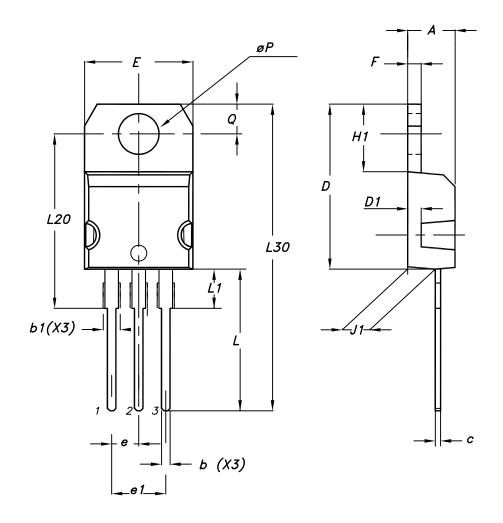
Таре		Reel			
Dim.	mm		Disc	mm	
	Min.	Max.	– Dim.	Min.	Max.
A0	6.8	7	A		330
B0	10.4	10.6	В	1.5	
B1		12.1	С	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
E	1.65	1.85	N	50	
F	7.4	7.6	Т		22.4
K0	2.55	2.75			
P0	3.9	4.1	Bas	se qty.	2500
P1	7.9	8.1	Bul	Bulk qty.	
P2	1.9	2.1			
R	40				
т	0.25	0.35			
W	15.7	16.3			



4.4 TO-220 type A package information

Figure 26. TO-220 type A package outline





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Dim.		mm	
	Min.	Тур.	Max.
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.55
С	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10.00		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13.00		14.00
L1	3.50		3.93
L20		16.40	
L30		28.90	
øP	3.75		3.85
Q	2.65		2.95

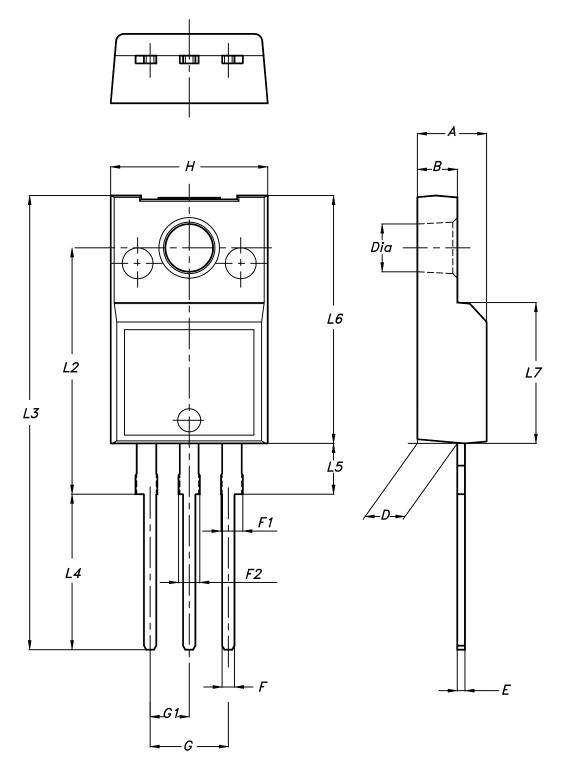
Table 12. TO-220 type A package mechanical data



4.5 TO-220FP package information

57

Figure 27. TO-220FP package outline



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Dim.		mm	
	Min.	Тур.	Max.
A	4.4		4.6
В	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

Table 13. TO-220FP package mechanical data



5 Ordering information

Table 14. Order codes

Order code	Marking	Package	Packing
STD5NK60ZT4	D5NK60Z	DPAK	Tape and reel
STP5NK60Z	P5NK60Z	TO-220	Tube
STP5NK60ZFP	P5NK60ZFP	TO-220FP	Tube

Revision history

Table 15.	Document	revision	history
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Date	Version	Changes
05-Apr-2005	1	First issue
29-Apr-2005	2	Modified value in Table 7.
06-Sep-2005	3	Inserted Ecopack indication
14-Oct-2005	4	Modified value on Table 1
28-Oct-2005	5	Tape & Reel info added
14-Nov-2005	6	Modified value on Table 6
15-Dec-2005	7	Various corrections
		Removed maturity status indication from cover page. The document status is production data.
22-Aug-2018	8	Updated Section 4 Package information.
		Minor text changes.



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